RECEIVED CENTRAL FAX CENTER

**FAX** 

MAR 0 2 2006

Date of transmission: March 2, 2006 Number of pages, including cover: 4

To: Examiner Alexander O. Williams (571) 273-8300

From: Anne Vachon Dougherty 3173 Cedar Road Yorktown Hts, NY 10598 phone (914) 962-5910 fax: (914) 962-1973

Re; Docket No: YOR920030098US1 Serial No: 10/729,254

Comments:

Response with election attached

THIS FAX CONTAINS CONFIDENTIAL MATTER. IF RECEIVED IN ERROR, PLEASE CONTACT THE SENDER AT THE ABOVE TELEPHONE NUMBER. PLEASE DO NOT RE-TRANSMIT THE CONTENTS OF THIS FAX.

## RECEIVED CENTRAL FAX CENTER

MAR 0 2 2006

I HEREBY CERTIFY THAT THIS CORRESPONDENCE
IS BEING TRANSMITTED VIA FAX TO (571) 273-8300
ON DATE OF DEPOSIT MAKEN 2, 2006
PERSON TRANSMITTING ANNE VACHON DOUGHERTY

AND PARTY OF THE PROPERTY SIGNATURE

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

March 2, 2006 In Re Application of :

ANNE V.DOUGHERTY

Group Art No.: 2826 : D. C. Edelstein, et al

Examiner: A. O. Williams Serial No. 10/729,254 :

for IBM Corporation Filed: December 5, 2003

Anne Vachon Dougherty

3173 Cedar Road Title: SILICON CHIP CARRIER

Yorktown Hts, NY 10598 WITH CONDUCTIVE THROUGH-VIAS

AND METHOD FOR FABRICATING SAME

## RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents

Sir:

In response to the Requirement for Restriction dated February 3, 2006, Applicants aver the following:

Claims 26-42 of the original parent application have been withdrawn from prosecution;

Applicants assert that Claim 1 is generic and that the species of the claimed invention include:

YOR920030098US1

Species 1, figures 2A, 2B and 2C covered by sub-genus Claim 7 which recites the semiconductor carrier structure of Claim 1 wherein said each conductive structure comprises a first conductive via material disposed in annular shape along the sidewalls of said through-via and having a core structure comprising a second via material. Under the sub-genus Claim 7 are the species having variations of the core structure which include the following:

Species 1(a), figure 2A having a first conductive annular ring and an inner core structure of one different material, covered by generic Claim 1, sub-genus Claim 7, and species Claims 8-14;

Species 1(b), figure 2B having a first conductive annular ring and an inner core structure comprising a sealed void, covered by generic Claim 1, sub-genus Claim 7, and species Claim 15;

Species 1(c), figure 2C having a first conductive annular ring and an inner core structure comprising more than one ring, covered by generic Claim 1, sub-genus Claim 7, and a no other species claims at this time;

Species 2, figure 2D wherein there is one via fill material, covered by generic Claim 1 and species Claims 2-6 and 16-19.

YOR920030098US1

Applicants note that Claims 20-25 depend from Claim 1, but recite structural features which can be used with any one of the species;

Applicants elect to prosecute Claims 1-26;

ANNE V. DOUGHERTY

Should the generic claim fall, Applicants provisionally elect to prosecute Species 1, the sub-genus covered by Claim 7 and Claims 8-15; and

Should the sub-genus claim fall, Applicants provisionally elect to prosecute Species 1(a), the species covered by Claims 8-14.

Applicants point out that a Continuation-in-Part (CIP) application has been filed for the above-identified patent application (serial number 11/242,221). The undersigned attorney placed a telephone call to Examiner Williams to determine if the Restriction Requirement would be withdrawn in view of the filing of the CIP application. Since the requirement has not been withdrawn, Applicants are filing this Response.

> Respectfully submitted, D. Edelstein, et al

Registration No. 30,87 Tel. (914) 962-5910

YOR920030098US1